


Amdt. Dated July 29, 2003

Reply to Office Action of Jan. 29, 2003

Amendment to the Specification:

Please replace the abstract with the following amended abstract:

ABSTRACT OF THE DISCLOSURE

 A heat shrinkable film laminate contains ~~(a)~~ a heatable shrinkable film, ~~(b)~~ a solventless adhesive and ~~(c)~~ a film having a heat shrinkage of at least 5% less than the heat shrinkable film ~~(a)~~ the heatable shrinkable film. Preferably the laminate also contains ~~(d)~~ a barrier layer adjacent ~~(a)~~ the heatable shrinkable film.
